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CLAIMS

What is claimed is:

- 1. A structure (10, 20) comprising at least one proportional variable resistor (24) suitable for electrically measuring unidirectional misalignment of stitched masks in etched interconnect layers, said structure comprising at least a first mask (10) and a second mask (20) that when superimposed comprise at least two test pads (14, 16) and interconnects (12, 22) the resistance between (24) which can be measured.
- 2. The invention according to claim 1 comprising at least one directly proportional variable resistor.
- 3. The invention according to claim 1 comprising at least one inversely proportional variable resistor.
- 4. The invention (30, 50) according to claim 1 comprising at least one stick type (32, 24, 36, 38) interconnect.
- 5. The invention according (60, 70) to claim 1 comprising at least one hook type interconnect (62, 72).
- 6. A system for electrically measuring unidirectional misalignment of stitched masks in etched interconnect layers, said system comprising at least one proportional variable resistor comprising a reference mask comprising at least two test pads and a second mask comprising at least one interconnect; and a probe for testing the resistance between said interconnect of said reference mask and said interconnect of said second mask when said masks are superimposed.
- 7. The invention according to claim 6, the at least one interconnect of said reference mask comprising at least one stick type interconnect.
- 8. The invention according to claim 6, the at least one interconnect of said reference mask comprising at least one hook type interconnect.
- 9. The invention according to claim 6, the at least one interconnect of said second mask comprising at least one stick type interconnect.
- 10. The invention according to claim 6, the at least one interconnect of said second mask comprising at least one hook type interconnect.
- 11. The invention according to claim 6, said system comprising at least one inversely proportional variable resistor.
- 12. The invention according to claim 6, said system comprising at least one directly proportional variable resistor.

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13. A method of measuring stitched mask misalignment in etched interconnect layers comprising the steps of: providing a reference mask comprising at least two test pads; providing a second mask comprising at least one interconnect; superimposing said reference mask and said second mask to provide at least one proportional variable resistor; electrically measuring the resistance of said at least one proportional variable resistor.

- 14. The method according to claim 13 further comprising the step of establishing an optimum resistance between said test pads.
- 15. The invention according to claim 14 comprising the further steps of comparing a measured resistance to said optimum resistance and adjusting the position of said masks to alignment.